



IEC 62734

Edition 1.1 2019-07  
CONSOLIDATED VERSION

# INTERNATIONAL STANDARD

## NORME INTERNATIONALE



Industrial networks – **iTeh Standards**  
Wireless communication network and communication profiles – ISA 100.11a  
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Réseaux industriels – **Document Preview**  
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IEC Central Office  
3, rue de Varembé  
CH-1211 Geneva 20  
Switzerland

Tel.: +41 22 919 02 11  
[info@iec.ch](mailto:info@iec.ch)  
[www.iec.ch](http://www.iec.ch)

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INTERNATIONAL  
ELECTROTECHNICAL  
COMMISSION

COMMISSION  
ELECTROTECHNIQUE  
INTERNATIONALE

ICS 33.160.60; 33.170

ISBN 978-2-8322-7238-1

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